



**ALPHA & OMEGA**  
SEMICONDUCTOR

# ***Alpha & Omega Semiconductor Product Reliability Report***

**AOZ2263VQI-02**, rev A

**Plastic Encapsulated Device**

**ALPHA & OMEGA Semiconductor, Inc**

**[www.aosmd.com](http://www.aosmd.com)**

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This AOS product reliability report summarizes the qualification results for AOZ2263VQI-02 in QFN4x4-22L package. Accelerated environmental tests are performed on a specific sample size and samples are electrically tested before and after each time point. Review of final electrical test results confirm that AOZ2263VQI-02 pass the AOS quality and reliability requirements. The released products will be categorized by its process family and routinely monitored for continuous improvement of product quality.

## I. Reliability Stress Test Summary and Results

| Test Item                | Test Condition   | Time Point              | Total Sample Size | Number of Failures | Reference Standard |
|--------------------------|--|-------------------------|-------------------|--------------------|--------------------|
| HTOL                     | $T_J = 125^{\circ}\text{C}$ ,<br>$V_{IN} = V_{ccmax}$  | 168 / 500 / 1000 hours  | 231 pcs           | 0                  | JESD22-A108        |
| Preconditioning (Note A) | $T_A = 30^{\circ}\text{C}$ , RH = 60% +<br>3 cycle reflow @ $260^{\circ}\text{C}$<br>(MSL 3) | 192 hours               | 1155 pcs          | 0                  | JESD22-A113        |
| HAST                     | $T_A = 130^{\circ}\text{C}$ , RH = 85%,<br>P = 33.3psia,<br>$V_{IN} = V_{ccmax}$             | 96 hours                | 231 pcs           | 0                  | JESD22-A110        |
| THB                      | $T_A = 85^{\circ}\text{C}$ , RH = 85%,<br>$V_{IN} = V_{ccmax}$                               | 168 / 500 / 1000 hours  | 231 pcs           | 0                  | JESD22-A101        |
| Autoclave                | $T_A = 121^{\circ}\text{C}$ , RH = 100%,<br>P = 29.7psia                                     | 96 hours                | 231 pcs           | 0                  | JESD22-A102        |
| Temperature Cycle        | $T_A = -65^{\circ}\text{C}$ to $150^{\circ}\text{C}$ ,<br>air to air                         | 250 / 500 / 1000 cycles | 231 pcs           | 0                  | JESD22-A104        |
| HTSL                     | Temp = $150^{\circ}\text{C}$   | 168 / 500 / 1000 hours  | 231 pcs           | 0                  | JESD22-A103        |

**Note:** The reliability data presents total of available generic data up to the published date.

Note A: MSL (Moisture Sensitivity Level) 3 based on J-STD-020

## II. Reliability Evaluation

**FIT rate (per billion): 50.97**

**MTTF = 2240 years**

The presentation of FIT rate for the individual product reliability is restricted by the actual burn-in sample size. Failure Rate Determination is based on JEDEC Standard JESD 85. FIT means one failure per billion hours.

**Failure Rate** =  $\text{Chi}^2 \times 10^9 / [2 (N) (H) (Af)] = 50.97$

**MTTF** =  $10^9 / \text{FIT} = 2240$  years

**Chi<sup>2</sup>** = Chi Squared Distribution, determined by the number of failures and confidence interval

**N** = Total Number of units from burn-in tests

**H** = Duration of burn-in testing

**Af** = Acceleration Factor from Test to Use Conditions ( $E_a = 0.7\text{eV}$  and  $T_{use} = 55^{\circ}\text{C}$ )

Acceleration Factor **[Af]** = **Exp** [ $E_a / k (1/T_J u - 1/T_J s)$ ]

**Acceleration Factor ratio list:**

|           | 55 deg C  | 70 deg C  | 85 deg C   | 100 deg C  | 115 deg C  | 125 deg C |
|-----------|-----------|-----------|------------|------------|------------|-----------|
| <b>Af</b> | <b>77</b> | <b>26</b> | <b>9.8</b> | <b>3.9</b> | <b>1.7</b> | <b>1</b>  |

$T_{js}$  = Stressed junction temperature in degree (Kelvin),  $K = C + 273.16$

$T_{ju}$  = The use junction temperature in degree (Kelvin),  $K = C + 273.16$

$k$  = Boltzmann's constant,  $8.617164 \times 10^{-5} \text{ eV / K}$

### III. ESD and Latch Up Test Results

| Test   | Test Conditions   | Total Sample Size | Number of Failures | Reference Standard |
|--|---|-------------------|--------------------|--------------------|
| Electrostatic Discharge Human Body Model     | $T_A = 25^\circ\text{C}$ , $\pm 2.5\text{kV}$                         | 3                 | 0                  | JESD-A114          |
| Electrostatic Discharge Charged Device Model | $T_A = 25^\circ\text{C}$ , $\pm 1\text{kV}$                           | 3                 | 0                  | JESD-C101          |
| Latch Up                                     | $T_A = 25^\circ\text{C}$ , $\pm 200\text{mA}$ , $1.5\times \text{OV}$ | 6                 | 0                  | JESD78             |
| Latch Up                                     | $T_A = 85^\circ\text{C}$ , $\pm 200\text{mA}$ , $1.5\times \text{OV}$ | 6                 | 0                  | JESD78             |

(1) ATE results are used to determine PASS/FAIL. Parametric shift  $<10\%$ .

